

HSP

NOTES:

Current Rating:3.0AMP
 Withstand Voltage:500V AC/DC
 Contact Resistance:20mΩ Max
 Insulation Resistance:1000MΩMin
 Operation Temperature: -40°C to+105°C

Contact Material:Phosphor Bronze
 Contact plating:Au or Sn over Ni
 Insulator Material:PA6T or PBT+30%G.F.(UL94V-0)

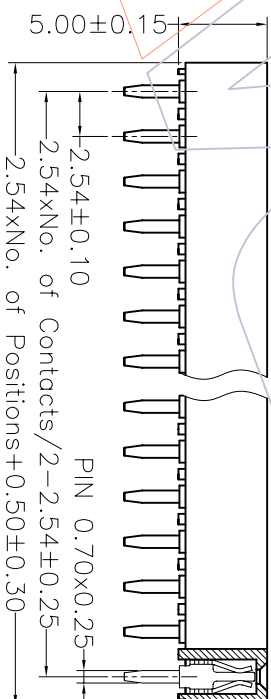
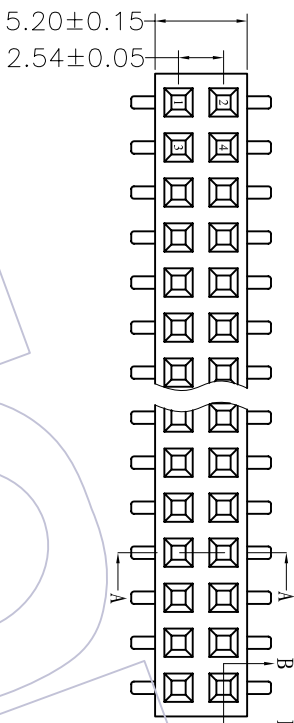
Ordering Information

2150 - 2 XX W XX X UN X I

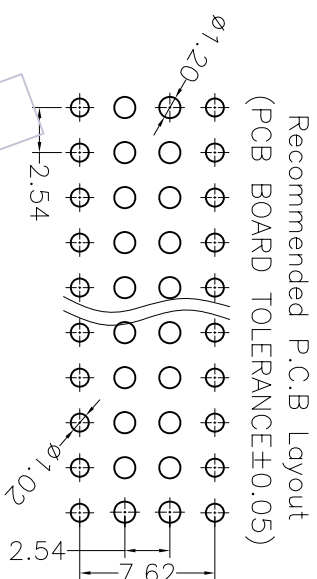
No. of Pins per ROW:02-40PIN
 Contact Plating:
 G0=Gold Flash
 G1=3µ"Gold
 G2=5µ"Gold
 G3=10µ"Gold
 G4=15µ"Gold
 G5=30µ"Gold
 S0=Gold Flash/Tin
 S1=3µ"Gold/Tin
 S2=5µ"Gold/Tin
 S3=10µ"Gold/Tin
 S4=15µ"Gold/Tin
 S5=30µ"Gold/Tin
 SN=Tin

Insulator:
 A=PBT
 C=PA6T

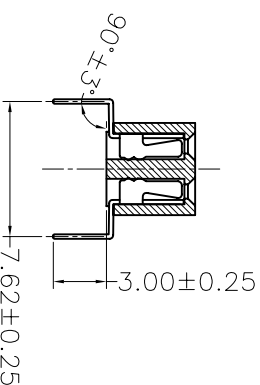
Packing:
 T=Tube



SECTION: B-B



Recommended P.C.B Layout
 (PCB BOARD TOLERANCE±0.05)



SECTION: A-A

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION		DRAW	WEIXD	08.06.11	SCALE		PART NO.	TITLE:
					XXX	±0.40				UNIT	SIZE		
A1	08/06/11	Changing P.C.B Layout			XXX	±0.25	DESIGN				A4	2150-2XXWXXXUNX1	FH2.54 DUAL Centipede H=5.0
A0	08/03/01	NEW			XXXX	±0.15	CHECK				1/1		
					Angle	± 3'	APPROVE						

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